

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LVX245F, TC74LVX245FW, TC74LVX245FT

Octal Bus Transceiver

The TC74LVX245F/ FW/ FT is a high-speed CMOS octal bus transceiver fabricated using silicon gate CMOS technology. Designed for use in 3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

These devices are suitable for low-voltage and battery operated systems.

It is intended for two-way asynchronous communication between data busses.

The direction of data transmission is determined by the level of the DIR input. The enable input (\bar{G}) can be used to disable the device so that the busses are effectively isolated.

All inputs are equipped with protection circuits against static discharge.

Features

- High-speed: $t_{pd} = 4.7 \text{ ns (typ.) (V}_{CC} = 3.3 \text{ V)}$
- Low power dissipation: $I_{CC} = 4 \text{ }\mu\text{A (max) (T}_a = 25^\circ\text{C)}$
- Input voltage level: $V_{IL} = 0.8 \text{ V (max) (V}_{CC} = 3 \text{ V)}$
 $V_{IH} = 2.0 \text{ V (min) (V}_{CC} = 3 \text{ V)}$
- Balanced propagation delays: $t_{pLH} \approx t_{pHL}$
- Low noise: $V_{OLP} = 0.8 \text{ V (max)}$
- Pin and function compatible with 74HC245

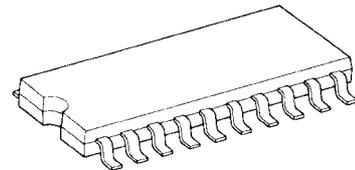
Note 1: Do not apply a signal to any bus pins when it is in the output mode. Damage may result.

All floating (high impedance) bus pins must have their input levels fixed by means of pull-up or pull-down resistors.

A parasitic diode is formed between the bus and V_{CC} terminals. Therefore bus terminal can not be used to interface 5-V to 3-V systems directly.

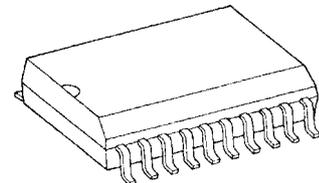
Note: xxxFW (JEDEC SOP) is not available in Japan.

TC74LVX245F



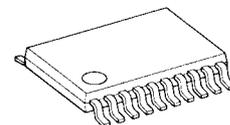
SOP20-P-300-1.27

TC74LVX245FW



SOL20-P-300-1.27

TC74LVX245FT



TSSOP20-P-0044-0.65

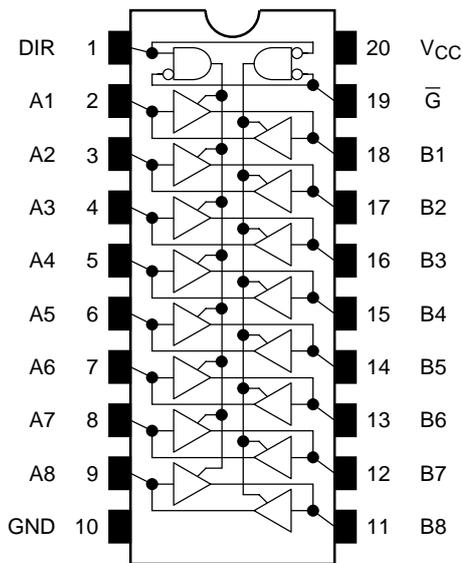
Weight

SOP20-P-300-1.27: 0.22 g (typ.)

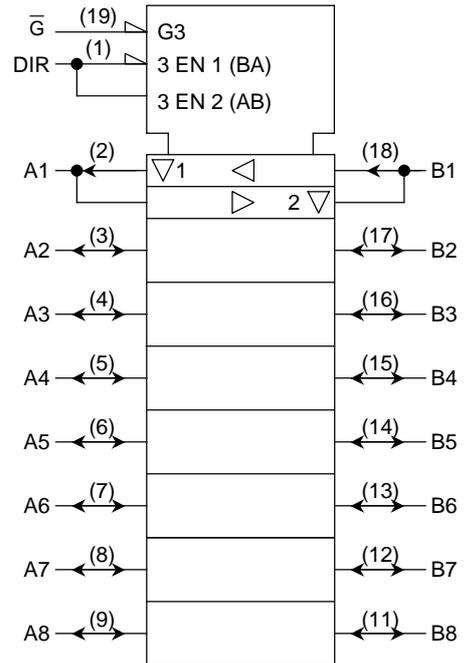
SOL20-P-300-1.27: 0.46 g (typ.)

TSSOP20-P-0044-0.65: 0.08 g (typ.)

Pin Assignment (top view)



IEC Logic Symbol



Truth Table

Inputs		Outputs	Function	
\bar{G}	DIR		A-Bus	B-Bus
L	L	A = B	Output	Input
L	H	B = A	Input	Output
H	X	Z	High impedance	

X: Don't care

Z: High impedance

Maximum Ratings

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CC}	-0.5 to 7.0	V
DC input voltage (DIR, \bar{G})	V_{IN}	-0.5 to 7.0	V
DC bus I/O voltage	$V_{I/O}$	-0.5 to $V_{CC} + 0.5$	V
Input diode current	I_{IK}	-20	mA
Output diode current	I_{OK}	± 20	mA
DC output current	I_{OUT}	± 25	mA
DC V_{CC} /ground current	I_{CC}	± 75	mA
Power dissipation	P_D	180	mW
Storage temperature	T_{stg}	-65 to 150	$^{\circ}\text{C}$

Recommended Operating Conditions

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	2.0 to 3.6	V
Input voltage (DIR, \bar{G})	V_{IN}	0 to 5.5	V
Bus I/O voltage	$V_{I/O}$	0 to V_{CC}	V
Operating temperature	T_{opr}	-40 to 85	$^{\circ}\text{C}$
Input rise and fall time	dt/dv	0 to 100	ns/V

Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition	$T_a = 25^{\circ}\text{C}$			$T_a = -40$ to 85°C		Unit			
			V_{CC} (V)	Min	Typ.	Max	Min		Max		
Input voltage	H-level	V_{IH}	—	2.0	1.5	—	—	1.5	—	V	
				3.0	2.0	—	—	2.0	—		
				3.6	2.4	—	—	2.4	—		
	L-level	V_{IL}	—	2.0	—	—	0.5	—	0.5		
				3.0	—	—	0.8	—	0.8		
				3.6	—	—	0.8	—	0.8		
Output voltage	H-level	V_{OH}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -50 \mu\text{A}$	2.0	1.9	2.0	—	1.9	—	V
				$I_{OH} = -50 \mu\text{A}$	3.0	2.9	3.0	—	2.9	—	
				$I_{OH} = -4 \text{ mA}$	3.0	2.58	—	—	2.48	—	
	L-level	V_{OL}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 50 \mu\text{A}$	2.0	—	0	0.1	—	0.1	
				$I_{OL} = 50 \mu\text{A}$	3.0	—	0	0.1	—	0.1	
				$I_{OL} = 4 \text{ mA}$	3.0	—	—	0.36	—	0.44	
3-State output Off-state current	I_{OZ}	$V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = V_{CC}$ or GND	3.6	—	—	± 0.25	—	± 2.5	μA		
Input leakage current	I_{IN}	$V_{IN} = 5.5 \text{ V}$ or GND	3.6	—	—	± 0.1	—	± 1.0	μA		
Quiescent supply current	I_{CC}	$V_{IN} = V_{CC}$ or GND	3.6	—	—	4.0	—	40.0	μA		

AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$)

Characteristics	Symbol	Test Condition	Ta = 25°C			Ta = -40 to 85°C		Unit		
			V _{CC} (V)	C _L (pF)	Min	Typ.	Max		Min	Max
Propagation delay time	t _{pLH}	—	2.7	15	—	6.1	10.7	1.0	13.5	ns
				50	—	8.6	14.2	1.0	17.0	
	3.3 ± 0.3		15	—	4.7	6.6	1.0	8.0		
			50	—	7.2	10.1	1.0	11.5		
Output enable time	t _{pZL}	R _L = 1 kΩ	2.7	15	—	9.0	16.9	1.0	20.5	ns
				50	—	11.5	20.4	1.0	24.0	
	3.3 ± 0.3		15	—	7.1	11.0	1.0	13.0		
			50	—	9.6	14.5	1.0	16.5		
Output disable time	t _{pLZ}	R _L = 1 kΩ	2.7	50	—	11.5	18.0	1.0	21.0	ns
	t _{pHZ}		3.3 ± 0.3	50	—	9.6	12.8	1.0	14.5	
Output to output skew	t _{osLH}	(Note 2)	2.7	50	—	—	1.5	—	1.5	ns
	t _{osHL}		3.3 ± 0.3	50	—	—	1.5	—	1.5	
Input capacitance	C _{IN}	DIR, \bar{G}	(Note 3)		—	4	10	—	10	pF
Bus input capacitance	C _{I/O}	An, Bn			—	8	—	—	—	pF
Power dissipation capacitance	C _{PD}			(Note 4)	—	21	—	—	—	pF

Note 2: Parameter guaranteed by design.

$$(t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|)$$

Note 3: Parameter guaranteed by design.

Note 4: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

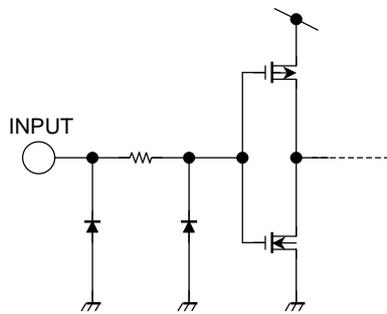
Average operating current can be obtained by the equation:

$$I_{CC(opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$$

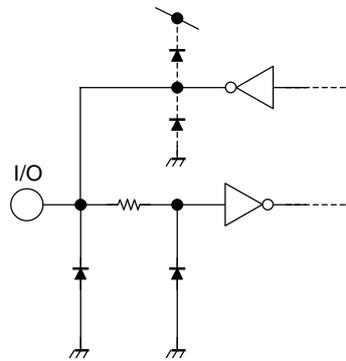
Noise Characteristics (Ta = 25°C, input: tr = tf = 3 ns, CL = 50 pF)

Characteristics	Symbol	Test Condition	VCC (V)	Typ.	Limit	Unit
Quiet output maximum dynamic	V _{OL}	V _{OLP}	3.3	0.5	0.8	V
Quiet output minimum dynamic	V _{OL}	V _{OLV}	3.3	-0.5	-0.8	V
Minimum high level dynamic input voltage	V _{IH}	V _{IHD}	3.3	—	2.0	V
Maximum low level dynamic input voltage	V _{IL}	V _{ILD}	3.3	—	0.8	V

Input Equivalent Circuit



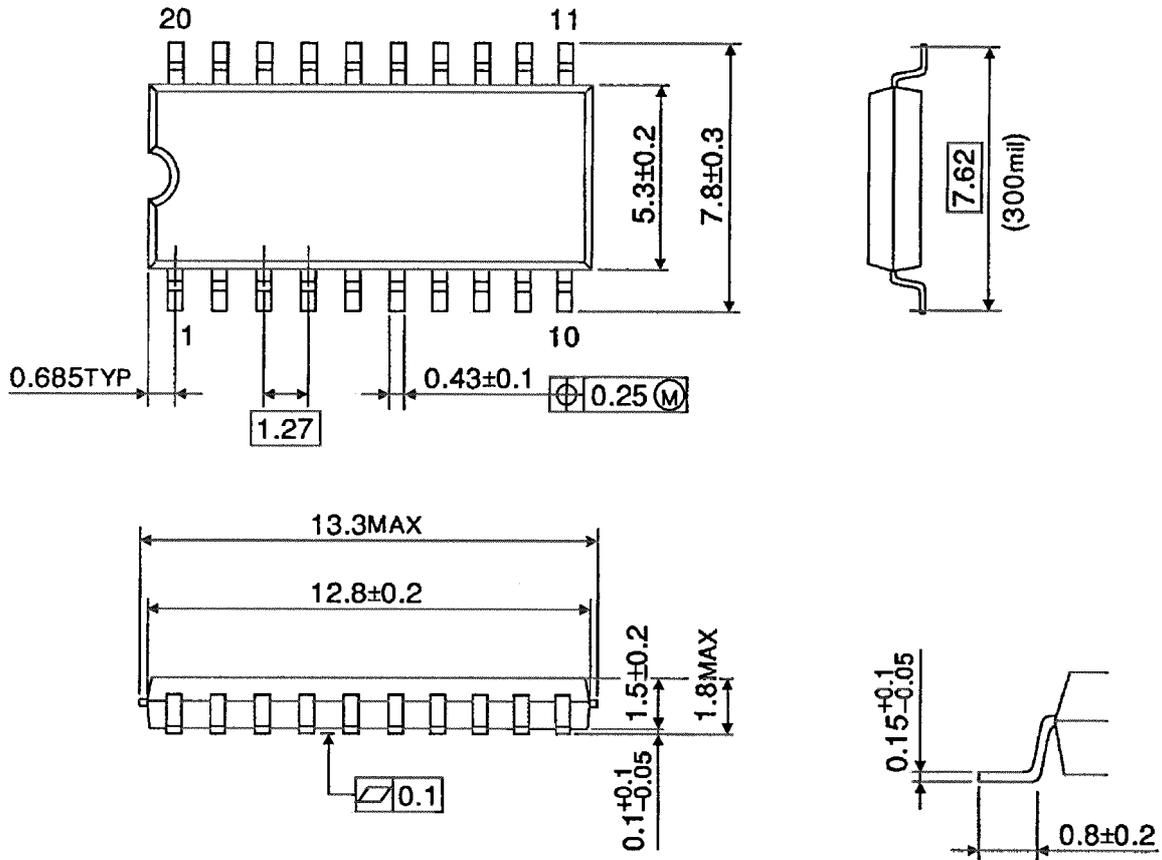
Bus Terminal Equivalent Circuit (An, Bn)



Package Dimensions

SOP20-P-300-1.27

Unit : mm

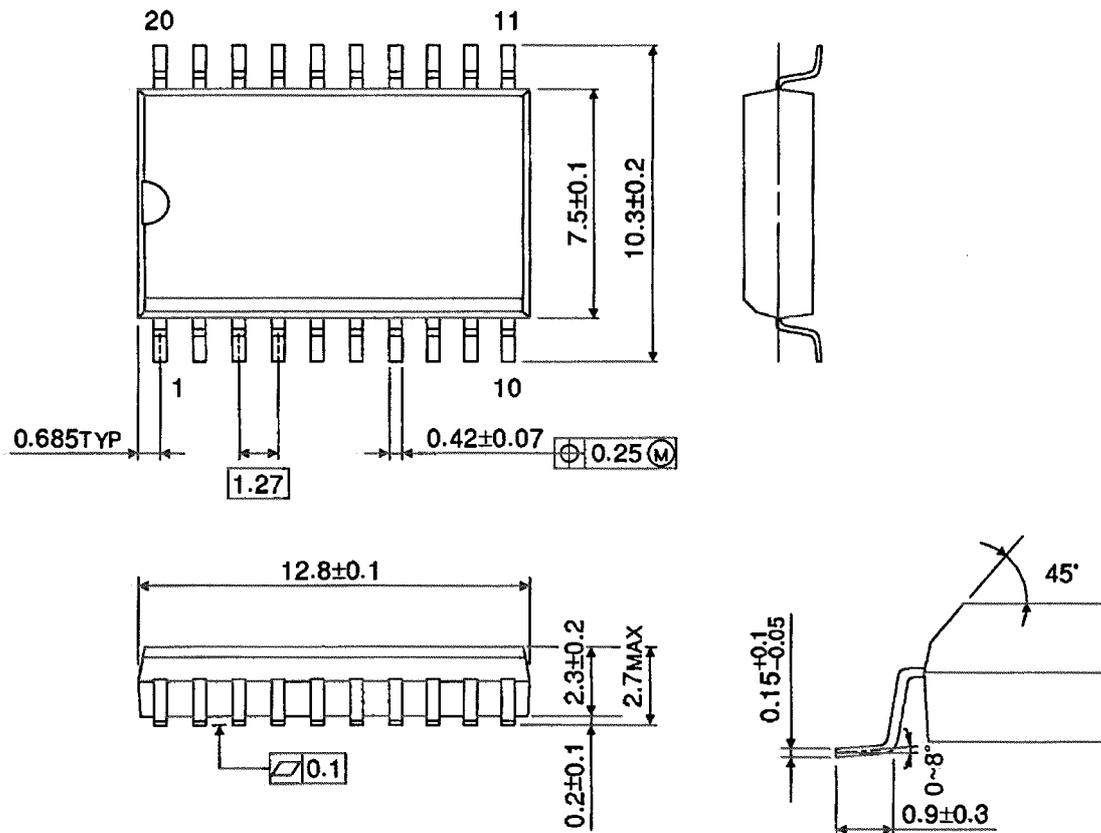


Weight: 0.22 g (typ.)

Package Dimensions

SOL20-P-300-1.27

Unit : mm

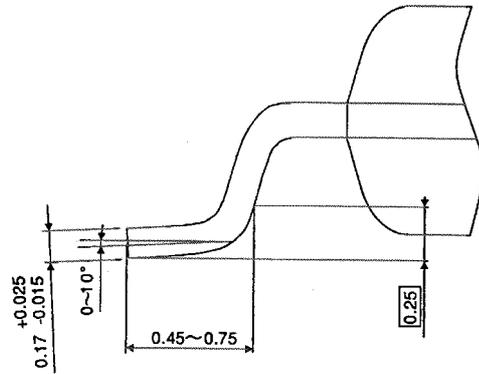
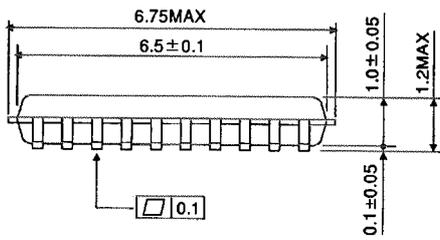
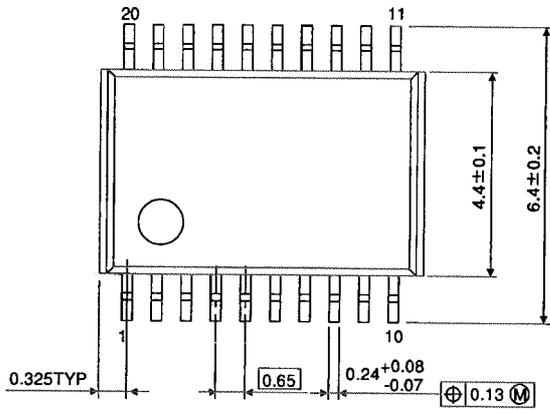


Weight: 0.46 g (typ.)

Package Dimensions

TSSOP20-P-0044-0.65

Unit : mm



Weight: 0.08 g (typ.)

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